

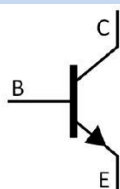
/ Descriptions

SOT-23 NPN

/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

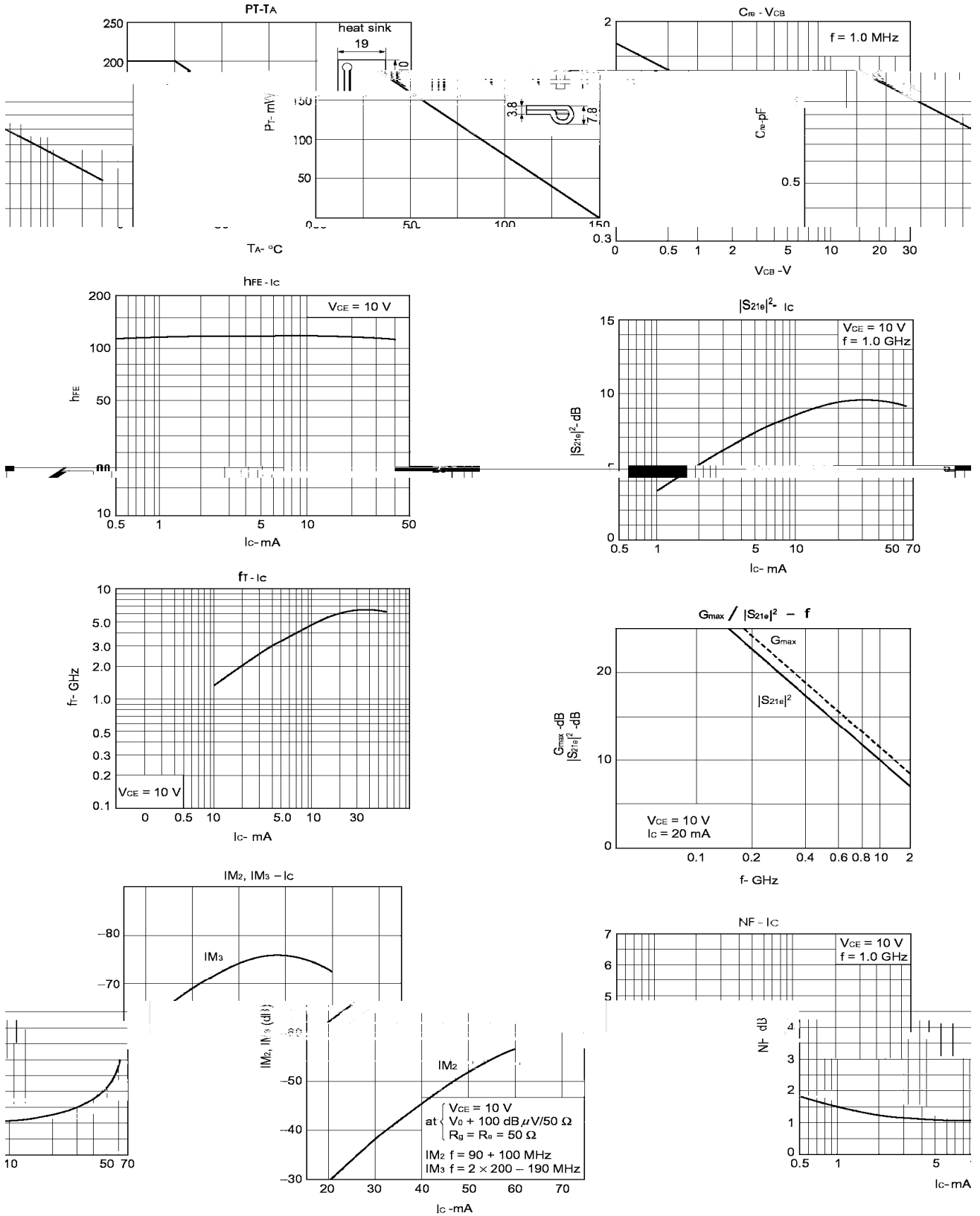


/ h_{FE} Classifications & Marking

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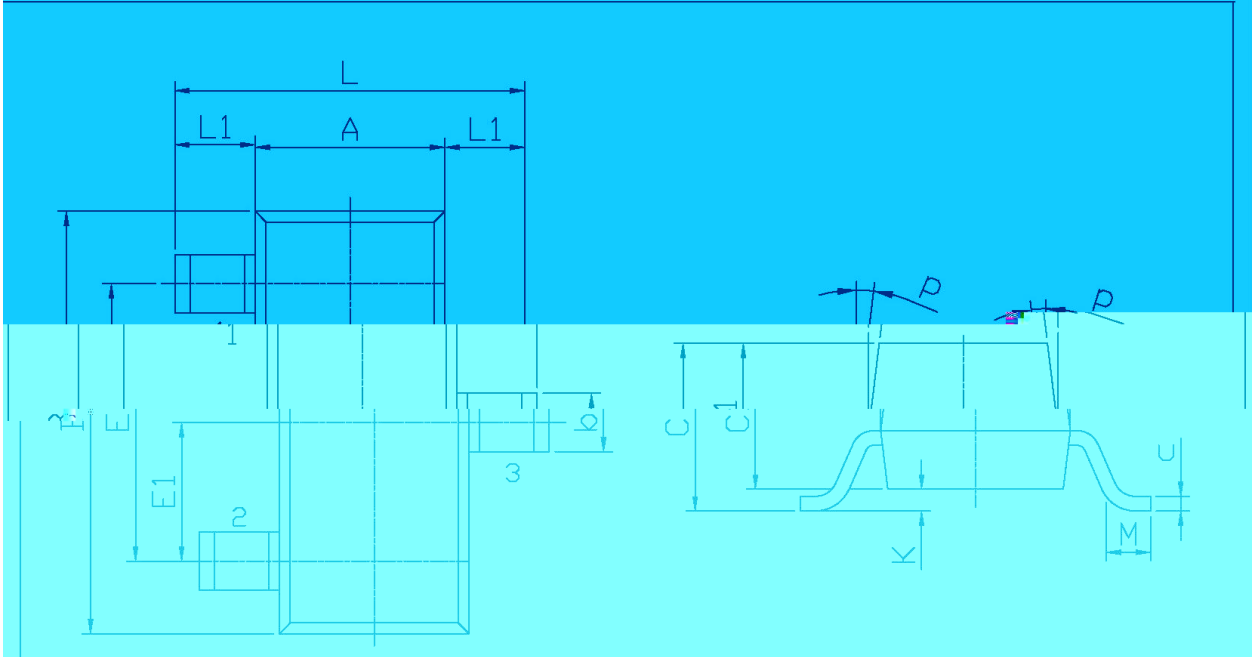
/ Electrical Characteristic Curve



/ Package Dimensions

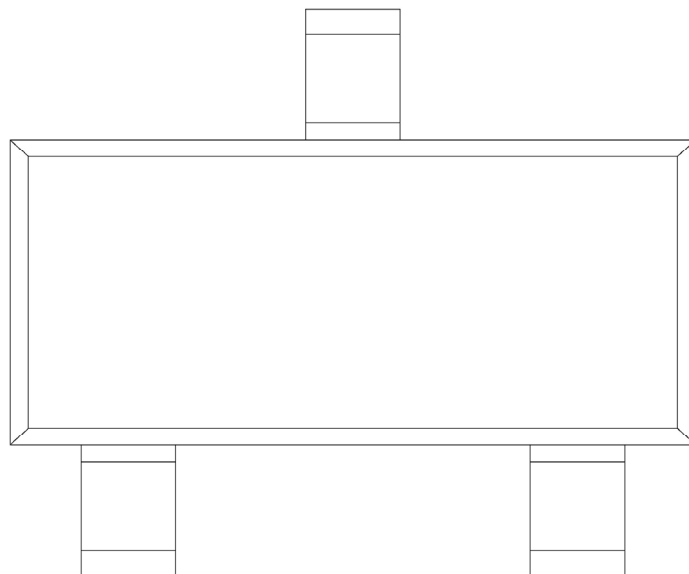
SOT-23

单位: mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	c	0.05	0.20
R	2.70	3.00			

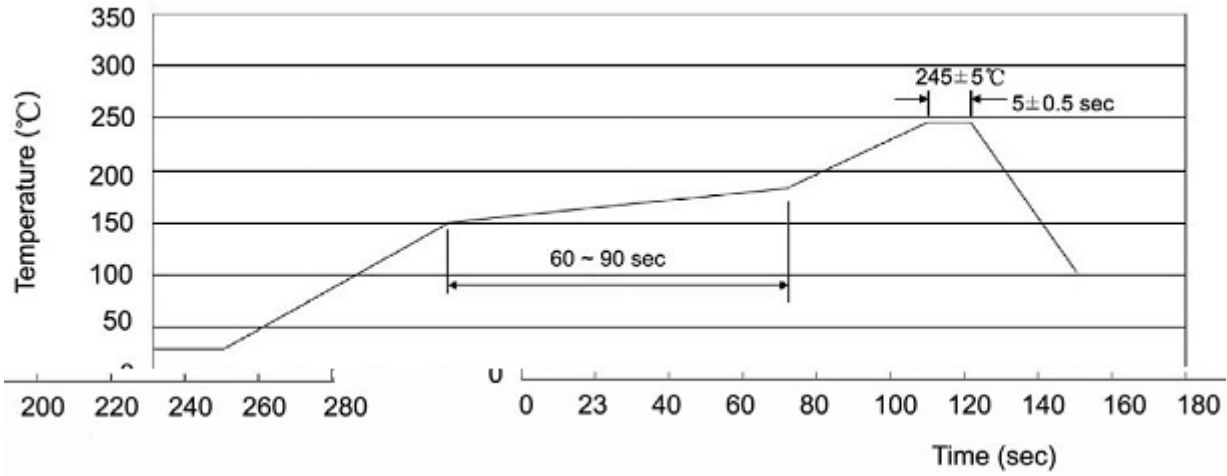
/ Marking Instructions



H
R23

H
R23

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	只卷盘	卷盘盒	只盒	盒箱	只箱	盒	箱	

/ Notices